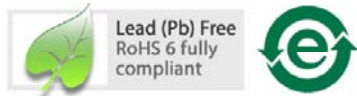


HSMW-C170

High Performance ChipLED

Data Sheet



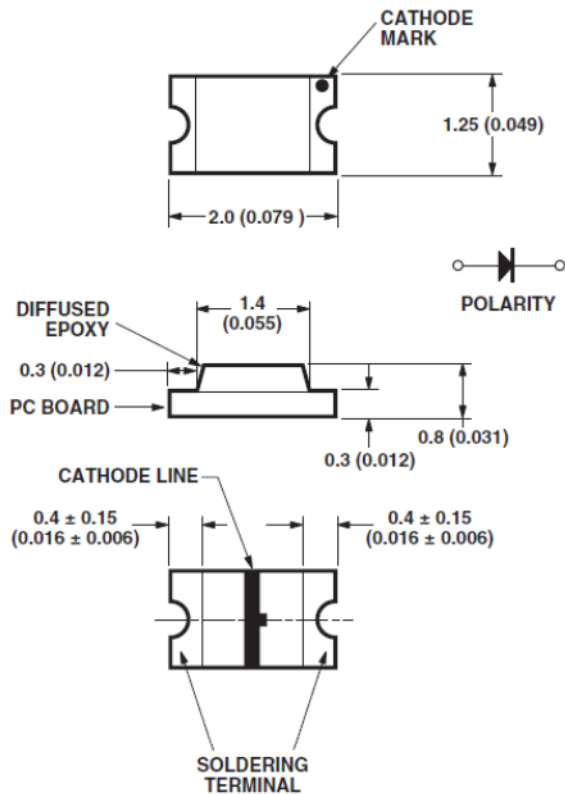
Feature

- LED with InGaN material
- Small size
- Industrial standard footprint
- Diffused optics
- Compatible with reflow soldering
- Available in 8mm tape on 7" diameter reel

Application

- LCD backlighting
- Push button backlighting
- Front panel indicator
- Symbol indicator

Package Dimension



Note:

1. All dimensions in mm (inches).
2. Tolerance ± 0.1 mm (0.004inch) unless otherwise specified.

Caution: LEDs are class 1A ESD sensitive per ANSI/ESDA/JEDEC JS-001. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

Absolute Maximum Ratings (T_A = 25°C)

Parameter	InGaN White	Unit
DC Forward Current ¹	20	mA
Power Dissipation	78	mW
Junction Temperature	95	°C
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-40 to +85	°C

Note:

1. Derate as shown in Figure 10.

Electrical / Optical Characteristics (T_A = 25°C, I_F = 20mA)

Parameter	Min	Typ	Max	Unit
Luminous Intensity, I _v ¹	180	370		mcd
Viewing Angle, 2θ _{1/2} ²		170		degree
Forward Voltage, V _F ³	2.9		3.9	V
Reverse Voltage, V _R ⁴ @ I _R = 100μA	5			V
Thermal Resistance, Rθ _{J-P}		300		°C/W

Note:

1. The luminous intensity is measured at the mechanical axis of the lamp package which may not be aligned with the peak of the spatial radiation pattern.
2. θ_{1/2} is the off axis angle where the luminous intensity is ½ the peak intensity.
3. V_F tolerance ±0.1V.
4. Indicates product final test condition, long term reverse bias is not recommended.

Intensity Bin Limits

Bin ID	Min. (mcd)	Max. (mcd)
S	180	285
T	285	450
U	450	715
V	715	1125
W	1125	1800
X	1800	2850
Y	2850	4500

Tolerance ±15%

Color Bin Limits

Bin ID	Chromaticity Coordinates	
	x	y
A1	0.2700	0.2455
	0.2700	0.2780
	0.2500	0.2500
	0.2500	0.2175
A2	0.2700	0.2455
	0.2700	0.2130
	0.2500	0.1850
	0.2500	0.2175
B1	0.2700	0.2455
	0.2700	0.2780
	0.2900	0.3060
	0.2900	0.2735
B2	0.2700	0.2455
	0.2700	0.2130
	0.2900	0.2410
	0.2900	0.2735

Bin ID	Chromaticity Coordinates	
	x	y
C1	0.2900	0.3060
	0.3100	0.3355
	0.3100	0.3030
	0.2900	0.2735
C2	0.2900	0.2410
	0.3100	0.2705
	0.3100	0.3030
	0.2900	0.2735
D1	0.3100	0.3030
	0.3100	0.3355
	0.3300	0.3650
	0.3300	0.3325
D2	0.3100	0.3030
	0.3100	0.2705
	0.3300	0.3000
	0.3300	0.3325

Tolerance ± 0.02

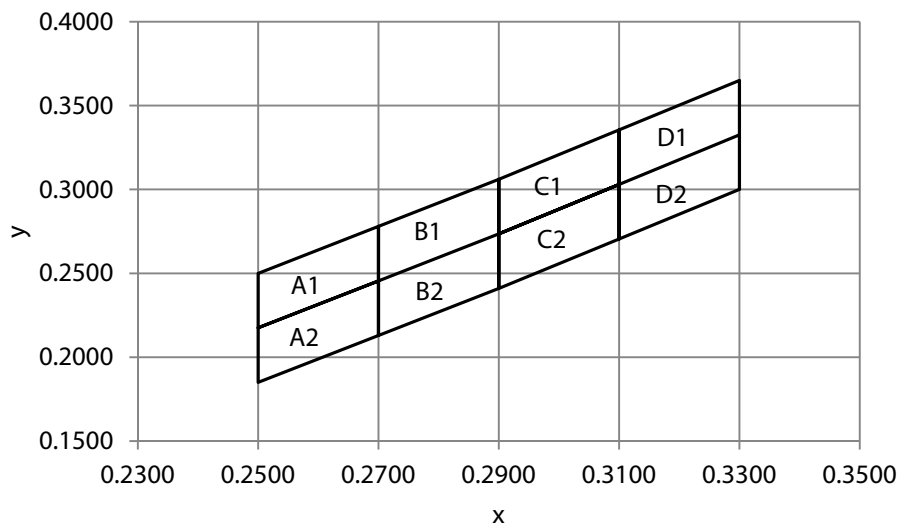


Figure 1. Chromaticity diagram

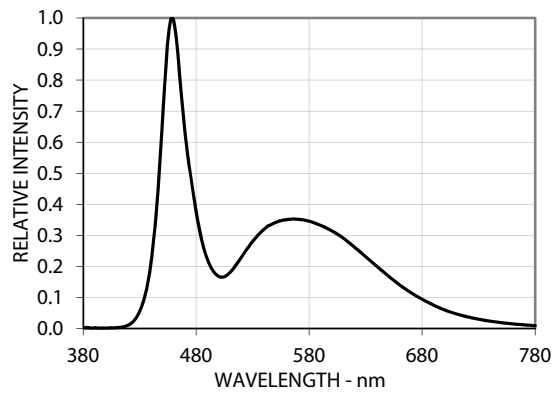


Figure 2. Spectrum

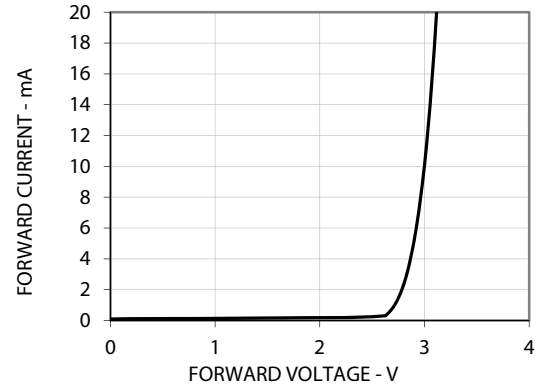


Figure 3. Forward current vs Forward voltage

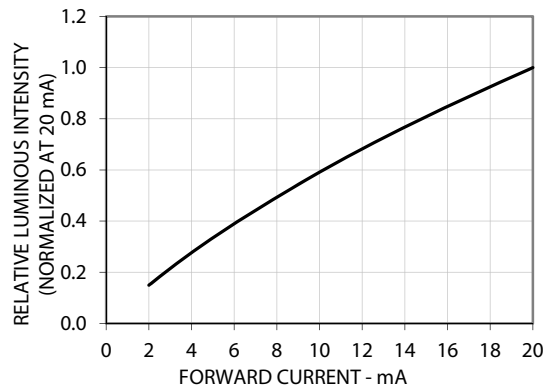


Figure 4. Relative intensity vs Forward current

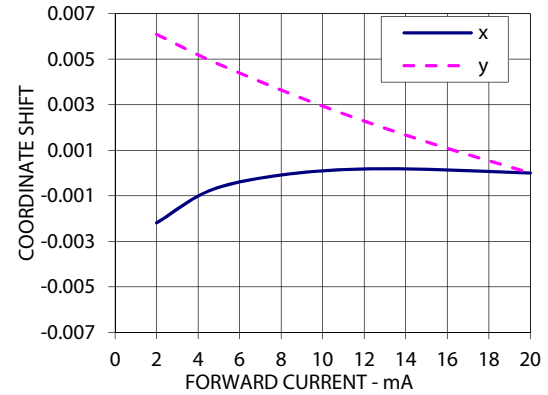


Figure 5. Chromaticity shift vs Forward current

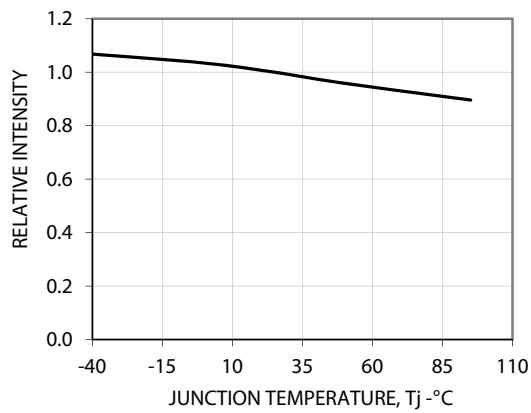


Figure 6. Relative intensity vs Temperature

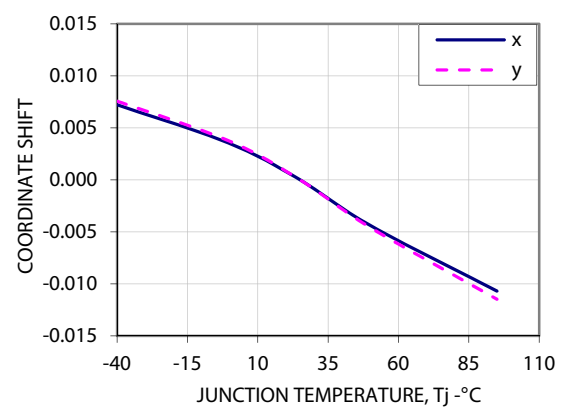


Figure 7. Chromaticity shift vs Temperature

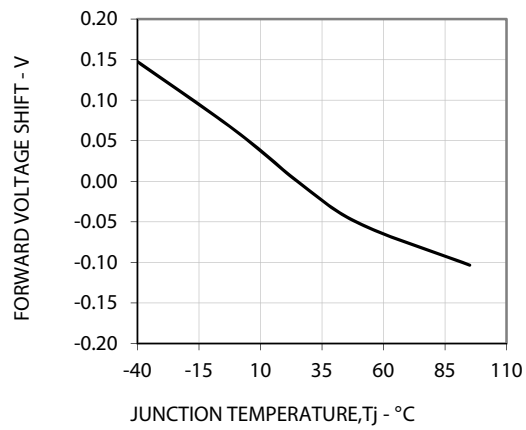


Figure 8. Forward voltage shift vs Temperature

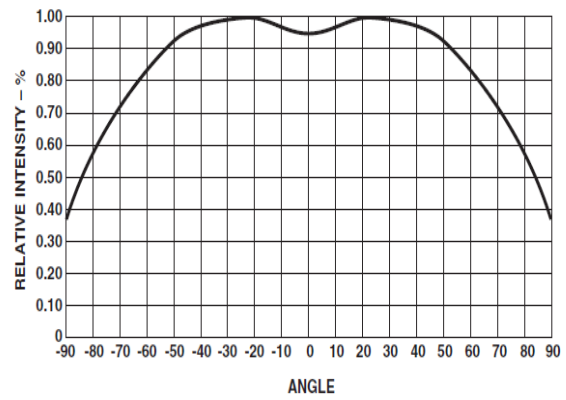


Figure 9. Radiation pattern

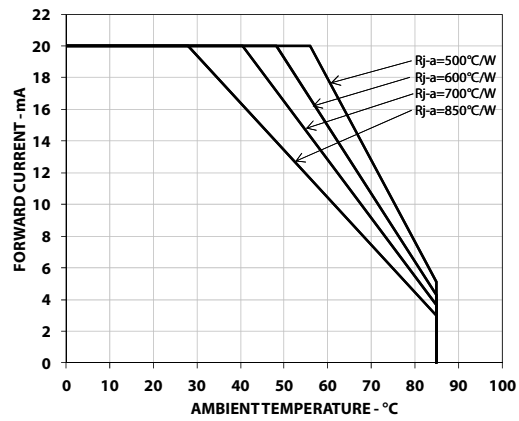


Figure 10. Derating curve

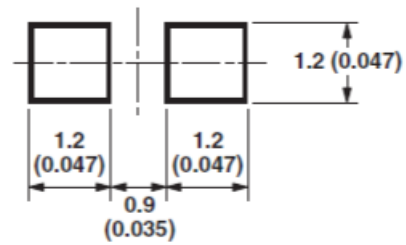
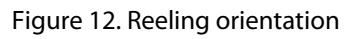
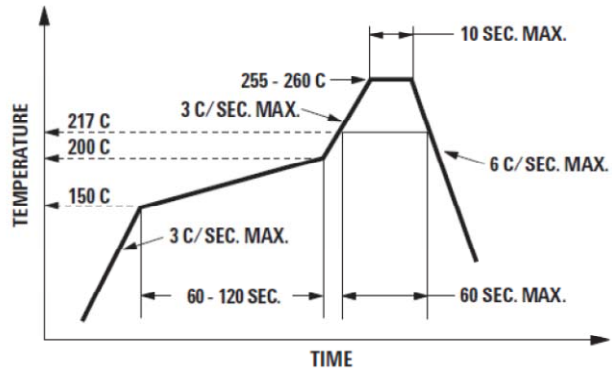


Figure 11. Recommended solder pad



Soldering

Recommended reflow soldering condition:



- Reflow soldering must not be done more than 2 times. Do observe necessary precautions of handling moisture sensitive device as stated in below section.
- Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.
- It is preferred to use reflow soldering to solder the LED. But if unavoidable (such as rework), manual hand soldering can be used but must be strictly controlled to condition below:
 - Soldering iron tip temperature = 310°C max
 - Soldering duration = 2sec max
 - Number of cycle = 1 only
 - Power of soldering iron = 50W max
- Do not touch the LED package body with the soldering iron except for the soldering terminals as it may cause damage to the LED.
- User is advised to confirm beforehand whether the functionality and performance of the LED is affected by hand soldering.

PRECAUTIONARY NOTES

1. Handling of moisture sensitive device

This product has a Moisture Sensitive Level 2a rating per JEDEC J-STD-020. Refer to Avago Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices*, for additional details and a review of proper handling procedures.

- (a) Before use
 - An unopened moisture barrier bag (MBB) can be stored at <40°C/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity Indicator Card (HIC) indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
 - It is recommended that the MBB not be opened prior to assembly (e.g. for IQC).
- (b) Control after opening the MBB
 - The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
 - The LEDs must be kept at <30°C / 60%RH at all times and all high temperature related processes including soldering, curing or rework need to be completed within 672 hours.
- (c) Control for unfinished reel
 - Unused LEDs must be stored in a sealed MBB with desiccant or desiccator at <5%RH.
- (d) Control of assembled boards
 - If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure that all LEDs have not exceeded their floor life of 672 hours.
- (e) Baking is required if:
 - The HIC indicator is not blue at 10% and is pink at 5%.
 - The LEDs are exposed to condition of >30°C / 60% RH at any time.
 - The LED floor life exceeded 672hrs.

The recommended baking condition is: 60±5°C for 20hrs
Baking should only be done once.

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